## SCHOTTKY BARRIER RECTIFIERS

Reverse Voltage - 40 to 200 V

Forward Current - 20 A

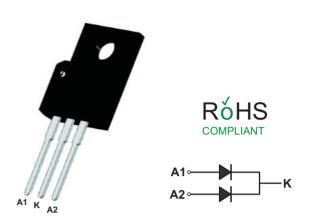
#### **FEATURES**

- · High current capability
- Low forward voltage drop
- · Low power loss, high efficiency
- High surge capability
- · High temperature soldering guaranteed
- Mounting position: any

Mechanical data
• Case: TO-220F-3L

• Approx. Weight: 1.7g ( 0.063oz)

• Terminals: Lead solderable per MIL-STD-202, Method 208



TO-220F-3L

#### MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified

CHARACTERISTICS		MBR2040FT	MBR2045FT	MBR2060FT	MBR20100FT	MBR20150FT	MBR20200FT	Units		
Maximum Recurrent Peak Reverse Voltage	$V_{RRM}$	40	45	60	100	150	200	V		
Maximum RMS voltage	V <sub>RMS</sub>	28	31.5	42	70 105		140	V		
Maximum DC Blocking Voltage	V <sub>DC</sub>	40	45 60		100	150	200	V		
Maximum Average Forward per diode Rectified Current per device	I <sub>F(AV)</sub>	10 20								
Peak Forward Surge Current,8.3ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method) per diode	I <sub>FSM</sub>	I <sub>FSM</sub> 150								
Max Instantaneous Forward Voltage at 10 A(per diode)	V <sub>F</sub>	0.7	70	0.75	0.85	0.90	0.92	V		
Maximum DC Reverse Current $T_a = 25$ °C at Rated DC Reverse Voltage $T_a = 125$ °C	I <sub>R</sub>	0.1 20					0.05 20			
Typical Junction Capacitance (1)	C <sub>j</sub>	200								
Typical Thermal Resistance (2)	R <sub>θJA</sub>	45								
Operating Junction Temperature Range	Tj	-55 ~ +150           -55 ~ +175								
Storage Temperature Range	$T_{stg}$	-55 ~ +150           -55 ~ +175						°C		

<sup>(1)</sup> Measured at 1 MHz and applied reverse voltage of 4 V D.C

<sup>(2)</sup> P.C.B. mounted with 10cmX10cmX1mm copper pad areas.



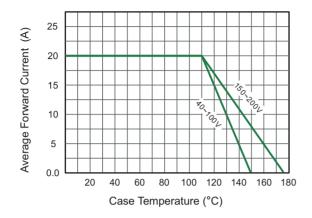


Fig.2 Typical Reverse Characteristics

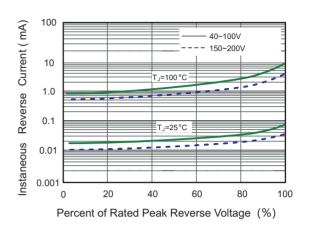


Fig.3 Typical Forward Characteristic(per leg)

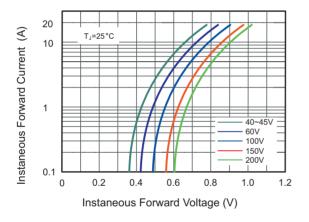


Fig.4 Typical Junction Capacitance

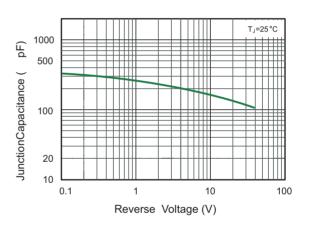


Fig.5 Maximum Non-Repetitive Peak Forward Surage Current

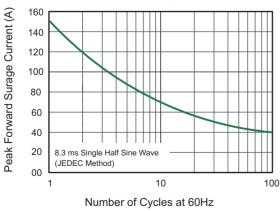
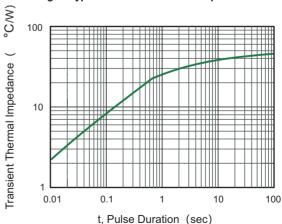
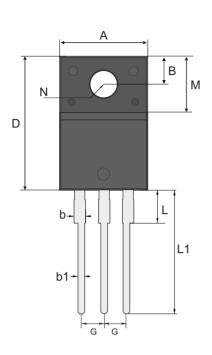


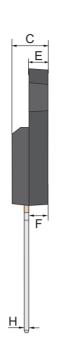
Fig.6- Typical Transient Thermal Impedance

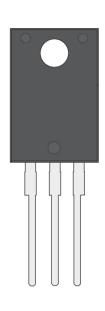


PACKAGE OUTLINE
Plastic Through hole package; 3 leads

## TO-220F-3L







TO-220F-3L mechanical data

UN	NIT .	А	В	b	b1	С	D	Е	F	G	Н	L	L1	М	N
	max	10.28	3.37	1.34	0.9	4.9	16.07	2.74	2.74	2.64	0.60	2.85	13.7	6.88	3.18 TYPICAL
mm	typ	10.18	3.27	1.24	0.8	4.7	15.87	2.54	2.54	2.54	0.50	2.65	13.5	6.68	
	min	10.08	3.17	1.14	0.7	4.5	15.67	2.34	2.34	2.44	0.40	2.45	13.3	6.48	
mil -	max	405	133	53	35	193	630	108	108	104	27	112	539	271	125 TYPICAL
	typ	401	129	49	31	185	590	100	100	100	20	104	531	267	
	min	397	125	45	28	177	580	92	92	96	16	96	524	255	

## **MARKING DIAGRAM**



YWW: Date Code Y:Years(0~9) WW:Week

MBR2040FT: Product name

(NOTE: The weekly code is based on the actual number of weeks in the calendar year.)

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